### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage

ouppiy voltage	
(AVDD, PVDD, HPVDD to	GND)0.3V to +6.0V
	±0.3V
	±0.3V
	-6.0V to + 0.3V
	0.3V to lower of
,	(HPVDD - CPVSS + 0.3V) and +9V
HPL, HPR to HPVDD	+0.3V to the higher of
	(CPVSS - HPVDD - 0.3V) and -9V
COM, SENSE	-0.3V to + 0.3V
	0.3V to (AVDD + 0.3V)
	veen OUT_+, OUT and GND,
PGND, AVDD, or PVDD	Continuous
Duration of Short Circuit betw	veen LDO_OUT and AVDD,
GND (Note 1)	Continuous
Duration of Short Circuit betw	veen HPR, HPL and
GND	Continuous
Continuous Current (PVDD, 0	OUT +, OUT -, PGND)1.7A
Continuous Current (C1N, C	1P. CPVSS. AVDD. HPVDD.
,	

Continuous Input Current (All Other Pins) Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	±20mA
28-Pin Thin QFN Single-Layer Board (derate	20.8mW/°C
above +70°C)	1667mW
Junction-to-Ambient Thermal Resistance ( $\theta_{JA}$	A)
(Note 2)	
Junction-to-Case Thermal Resistance ( $\theta_{\rm JC}$ )	
(Note 2)	2.7°C/W
28-Pin Thin QFN Multilayer Board (derate 28.	
above +70°C)	
Junction-to-Ambient Thermal Resistance (0JA	
(Note 2)	
Junction-to-Case Thermal Resistance ( $\theta_{\rm JC}$ )	
(Note 2)	2.7°C/W
ESD Protection, Human Body Model	
Operating Temperature Range	
Junction Temperature	
Storage Temperature Range	
Lead Temperature (soldering, 10s)	

#### Note 1: If short is present at power-up.

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maxim-ic.com/thermal-tutorial</u>.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2\mu F (C_{LDO} = 4\mu F \text{ for } 1.8V LDO \text{ option}), C1 = C2 = 1\mu F. R_L = \infty$ , unless otherwise specified.  $R_{IN1} = 20k\Omega$  ( $A_{VSPKR} = 12dB$ ),  $R_{IN2} = 40.2k\Omega$  ( $A_{VHP} = 0dB$ ),  $C_{IN1} = 470nF$ ,  $C_{IN2} = C_{COM} = 1\mu F$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 3)

PARAMETER	SYMBOL		CONDITI	ONS		MIN	ТҮР	MAX	UNITS
GENERAL	•								•
Supply Voltage	Guaranteed	d by PSRR te	st (Note 4	)	2.7		5.5	V	
Headphone Supply Voltage	Vhpvdd	Guaranteed	d by PSRR te	st		2.7		5.5	V
Undervoltage Lockout	UVLO							2.65	V
			SPKR_EN	HP_EN	LDO_EN				
			1	0	1		250	400	μA
		MAX9791	1	1	0		4.4	6	mA
	IAVDD +		0	0	0		10.5	15	
Quiescent Current	IPVD +		0	1	0		14.4	21	
	IHPVDD		1	0	1		250	400	μA
			1	1	0		4.4	6	
		MAX9792	0	0	0		10.5	18	mA
			0	1	0		14.4	24	1
Shutdown Current	ISHDN	SPKR_EN :	= 1.8V				3.3	73	μA
Bias Voltage	VBIAS	HP_INR, H	P_INL, SPKR	_INR, SPK	(R_INL		0		V

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2\mu F (C_{LDO} = 4\mu F \text{ for } 1.8V LDO \text{ option}), C1 = C2 = 1\mu F. R_L = \infty$ , unless otherwise specified.  $R_{IN1} = 20k\Omega$  ( $A_{VSPKR} = 12dB$ ),  $R_{IN2} = 40.2k\Omega$  ( $A_{VHP} = 0dB$ ),  $C_{IN1} = 470nF$ ,  $C_{IN2} = C_{COM} = 1\mu F$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 3)

PARAMETER	SYMBOL	C	ONDITION	IS	MIN	ТҮР	МАХ	UNITS
Shutdown to Full Operation	ton					0.4		ms
Overtemperature Threshold						+150		°C
SPEAKER AMPLIFIER								
		THD+N = 1%,	$\begin{vmatrix} R_{L} = 4\Omega \\ (MAX979 \end{vmatrix}$	1)		1.7		
		f = 1  kHz, $T_A = +25^{\circ}\text{C}$	$R_{L} = 8\Omega$ (MAX979	1)		1.2		
Output Dowor	Deur	(Note 5)	$R_{L} = 3\Omega$ (MAX979	2)		3		
Output Power	Pout	THD+N = 10%,	$R_{L} = 4\Omega$ (MAX979	1)		2.2		W
		f = 1 kHz, $T_A = +25^{\circ}C$	$R_{L} = 8\Omega$ (MAX979	1)		1.5		
		(Note 5)	$R_{L} = 3\Omega$ (MAX979	2)		3.7		
Total Harmonic Distortion Plus	THD+N	$R_L = 8\Omega, P_{OUT} =$	= 500mW,	f = 1kHz (Note 5)		0.04		0/
Noise		$R_L = 4\Omega$ , $P_{OUT} =$	= 500mW,	f = 1kHz (Note 5)		0.03		- %
		VAVDD = VPVDD	= 2.7V to \$	5.5V, T <sub>A</sub> = +25°C	60	80		
Power Cumply Pointion Datio	PSRR	f = 217Hz, 200r	nV <sub>P-P</sub>			73		dB
Power-Supply Rejection Ratio	Fonn	f = 1kHz, 200m			75			
		f = 10kHz, 200r	mV <sub>P-P</sub>			62		
Feedback Impedance	RFSKR	Guaranteed by d	design			20		kΩ
Gain	Av	$R_{IN1} = 20k\Omega$				12		dB
Output Offset Voltage	Vos	Measured betwee $T_A = +25^{\circ}C$	een OUT_+	- and OUT,		±3	±10	mV
Click and Pap Loval	Kop	R <sub>L</sub> = 8Ω, peak voltage, A-weighted,		Into shutdown		-52.4		dBV
Click-and-Pop Level	Кср	32 samples per (Notes 5, 6, and		Out of shutdown		-54		
		$R_L = 8\Omega$		A-weighted		98		
Signal-to-Noise Ratio	SNR	P <sub>OUT</sub> = 1.2W f <sub>IN</sub> (Note 5)	ı = 1kHz,	20Hz to 20kHz		94		dB
Noise	VN	A-weighted				38		μVRMS
		L to R, R to L, R <sub>L</sub> 100mV <sub>RMS</sub> , f <sub>IN</sub> =				78		
Crosstalk		L to R, R to L, R <sub>L</sub> 100mV <sub>RMS</sub> , f <sub>IN</sub> =				70		dB
		HP to SPKR, RLs $R_{LHP} = 32\Omega$ , $f_{IN}$				77		

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2\mu F (C_{LDO} = 4\mu F \text{ for } 1.8V LDO \text{ option}), C_1 = C_2 = 1\mu F. R_L = \infty$ , unless otherwise specified.  $R_{IN1} = 20k\Omega$  ( $A_{VSPKR} = 12dB$ ),  $R_{IN2} = 40.2k\Omega$  ( $A_{VHP} = 0dB$ ),  $C_{IN1} = 470nF$ ,  $C_{IN2} = C_{COM} = 1\mu F$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 3)

PARAMETER	SYMBOL	CO	NDITION	IS	MIN	ТҮР	MAX	UNITS
Class D Switching Frequency	fspk				948		1158	kHz
Spread-Spectrum Bandwidth						±15		kHz
Efficiency		Pout = 1.5W, fin =	= 1kHz,	$R_L = 8\Omega$ (Note 5)		83		%
HEADPHONE AMPLIFIER	•							
Output Power	Роит	THD+N = 1%, f = 1kHz,	RL	= 16Ω		100		mW
		$T_A = +25^{\circ}C$	RL	= 32Ω		180		
		$\begin{aligned} R_L &= 32\Omega, \ f_{IN} = 6k \\ V_{IN} &= -3dBFS = 21 \end{aligned}$				-78		dBFS
Total Harmonic Distortion Plus Noise	THD+N	$\begin{aligned} R_L &= 10 k\Omega,  f_{IN} = 6 \\ V_{IN} &= -3 dBFS = 50 \end{aligned}$				-87		
		$R_L = 32\Omega$ , $P_{OUT} =$	100mW	, f = 1kHz		0.006		%
		$R_L = 16\Omega$ , $P_{OUT} =$	75mW,	f = 1kHz		0.014		~~~
		V <sub>HPVDD</sub> = 2.7V to	5.5V, T <sub>A</sub>	= +25°C	70	107		
Power-Supply Rejection Ratio	PSRR	f = 1kHz, VRIPPLE		91		dB		
		f = 10kHz, VRIPPL		80				
Feedback Impedance	R <sub>FHP</sub>				38.2	40.2	42.2	kΩ
Gain	Av	$R_{IN2} = 40.2 k\Omega$				0		dB
Output Offset Voltage	Vos	$T_A = +25^{\circ}C$				±0.3	±3	mV
		$R_L = 32\Omega$ , peak voltage,		Into shutdown		-81		
Click-and-Pop Level	KCP	A-weighted, 32 sa per second (Notes		Out of shutdown		-72.5		dBV
Signal-to-Noise Ratio	SNR	$R_L = 32\Omega$ , $P_{OUT} =$	40mW,	A-weighted		102		dB
		f <sub>IN</sub> = 1kHz		20Hz to 20kHz		94		
Noise	V <sub>N</sub>	A-weighted				8		μVRMS
Maximum Capacitive Load	CL	No sustained osc	illations			100		pF
		L to R, R to L, f <sub>IN</sub> = 1kHz, COM		2Ω, V <sub>IN</sub> = FS = 30mV <sub>RMS</sub>		82		
		and SENSE connected		$0k\Omega, V_{IN} = -$ S = 0.7mV <sub>RMS</sub>		89		
Crosstalk		L to R, R to L, f <sub>IN</sub> = 15kHz, COM		2Ω, V <sub>IN</sub> = FS = 30mV <sub>RMS</sub>		64		dB
		and SENSE connected		$0k\Omega, V_{IN} = 5$ = 70.7mV <sub>RMS</sub>		70		
		SPKR to HP, R <sub>LSP</sub> R <sub>LHP</sub> = $32\Omega$ , f <sub>IN</sub> =		, P <sub>SPKR</sub> = 1W,		80		1

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### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2\mu F (C_{LDO} = 4\mu F \text{ for } 1.8V LDO \text{ option}), C1 = C2 = 1\mu F. R_L = \infty$ , unless otherwise specified.  $R_{IN1} = 20k\Omega$  ( $A_{VSPKR} = 12dB$ ),  $R_{IN2} = 40.2k\Omega$  ( $A_{VHP} = 0dB$ ),  $C_{IN1} = 470nF$ ,  $C_{IN2} = C_{COM} = 1\mu F$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 3)

PARAMETER	SYMBOL	CONDIT	IONS	MIN	ТҮР	MAX	UNITS
COM Input Range	Vcom	Inferred from CMRR tes	t	-300		+300	mV
Common-Mode Rejection Ratio	CMRR	-300mV < V <sub>COM</sub> < +300	DmV		60		dB
Slew Rate	SR				0.38		V/µs
Charge-Pump Frequency	fosc				530		kHz
BEEP INPUT (LDO_EN = 1)		•					
Beep Signal Minimum	fBEEP	Four-cycle count		215			Hz
Amplifier Turn-On Time	tonbeep				0.4		ms
Amplifier Hold Time	<b>t</b> HOLDBEEP			221	246	271	ms
LOW-DROPOUT LINEAR REGUL	ATOR						
LDO Ground Current	ILDO				0.25	0.4	mA
Output Current	Ιουτ	Inferred from load regul	ation			120	mA
Current Limit	ILIM				300		mA
Crosstalk		Speaker to LDO, $V_{LDO_{-}}$ f =1kHz, $I_{LDO_{-}OUT}$ = 10 = 1.2W, $R_{L}$ = 8 $\Omega$ (Note	mA, speaker POUT		-80		dB
Output Veltage Assures		$V_{LDO_OUT} = 4.75V$				±1.5	0/
Output-Voltage Accuracy		VLDO_OUT = 3.3V			±1.5	%	
		$V_{LDO_OUT} = 4.75V,$	I <sub>OUT</sub> = 50mA		46		
Dropout Voltage	VDO	$T_A = +25^{\circ}C$ (Note 8)	I <sub>OUT</sub> = 120mA		106		mV
Startup Time					30		μs
		$V_{AVDD} = 5V \text{ to } 5.5V, V_{LD}$ $I_{LDO_OUT} = 1mA, C_{LDO}$		-4.8	1.5	+4.8	
Line Regulation		$V_{AVDD} = 4.5V \text{ to } 5.5V, V$ $I_{LDO_OUT} = 1mA, C_{LDO}$		-4	0.2	+4	mV/V
		$V_{AVDD} = 3V$ to 5.5V, $V_{LD}$ ILDO_OUT = 1mA, CLDO		-6.4	2.5	+6.4	
Load Regulation		V <sub>LDO_OUT</sub> = 4.75V, 1mA 120mA	A < ILDO_OUT <		0.22		mV/mA
Ripple Rejection		$V_{\text{RIPPLE}} = 200 \text{mV}_{\text{P-P}},$	f = 1kHz		56		dB
		$V_{LDO_OUT} = 4.75V$ $I_{LDO_OUT} = 10mA$	f = 10kHz		40		
Output-Voltage Noise		20Hz to 20kHz, $C_{LDO_C}$ I <sub>LDO_OUT</sub> = 120mA		130		μVRMS	
DIGITAL INPUTS (SPKR_EN, HP	EN, LDO_E	N, BEEP)					
Input-Voltage High	VINH			1.4			V
Input-Voltage Low	V <sub>INL</sub>					0.4	V
Input Bias Current				-1		+1	μA



### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2\mu F (C_{LDO} = 4\mu F \text{ for } 1.8V LDO \text{ option}), C1 = C2 = 1\mu F. R_L = \infty$ , unless otherwise specified.  $R_{IN1} = 20k\Omega$  ( $A_{VSPKR} = 12dB$ ),  $R_{IN2} = 40.2k\Omega$  ( $A_{VHP} = 0dB$ ),  $C_{IN1} = 470nF$ ,  $C_{IN2} = C_{COM} = 1\mu F$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 3)

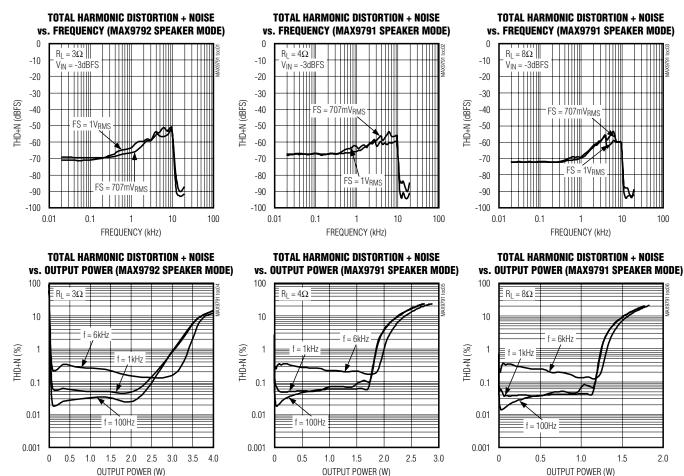
Note 3: All devices are 100% production tested at room temperature. All temperature limits are guaranteed by design.

- Note 4: AVDD and PVDD must be tied together. If LDO is enabled, set AVDD and PVDD as specified in the Line Regulation row of the *Electrical Characteristics* table.
- Note 5: Testing performed with a resistive load in series with an inductor to simulate an actual speaker load. For  $R_L = 3\Omega$ ,  $L = 22\mu$ H. For  $R_L = 4\Omega$ ,  $L = 33\mu$ H. For  $R_L = 8\Omega$ ,  $L = 68\mu$ H.
- **Note 6:** Specified at  $T_A = +25^{\circ}C$  with an  $8\Omega + 68\mu$ H load connected across BTL output for speaker amplifier. Specified at  $T_A = +25^{\circ}C$  with a  $32\Omega$  resistive load connected between HPR, HPL and GND for headphone amplifier. Speaker and headphone mode transitions are controlled by  $\overline{SPKR}_{EN}$  and HP\_EN inputs, respectively.
- Note 7: Amplifier Inputs AC-coupled to GND.
- Note 8: Guaranteed by ATE characterization; limits are not production tested.

### **Typical Operating Characteristics**

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 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)



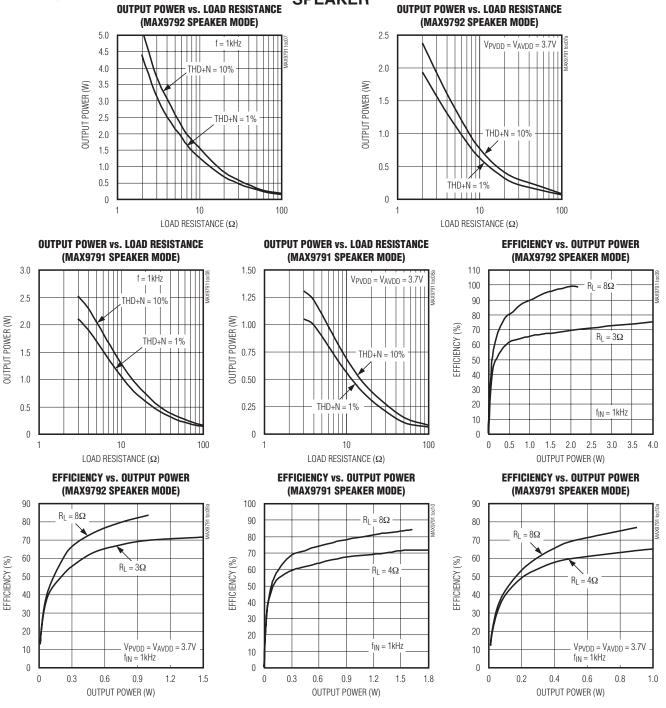
Note 6: Spec with a transi Note 7: Ampl Note 8: Guar (VAVDD = VPv erwise specifi

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### **Typical Operating Characteristics (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu\text{F}, C1 = C2 = 1\mu\text{F}, R_L = \infty, unless otherwise specified. R_{IN1} = 20k\Omega (A_{VSPKR} = 12dB), R_{IN2} = 40.2k\Omega (A_{VHP} = 0dB), C_{IN1} = 470n\text{F}, C_{IN2} = C_{COM} = 1\mu\text{F}, measurement BW = 20kHz AES17, T_A = +25^{\circ}\text{C}, unless otherwise noted. Speaker mode: <math>\overline{SPKR_EN} = 0, HP_EN = 0$ . Headphone mode:  $\overline{SPKR_EN} = 1, HP_EN = 1$ .)



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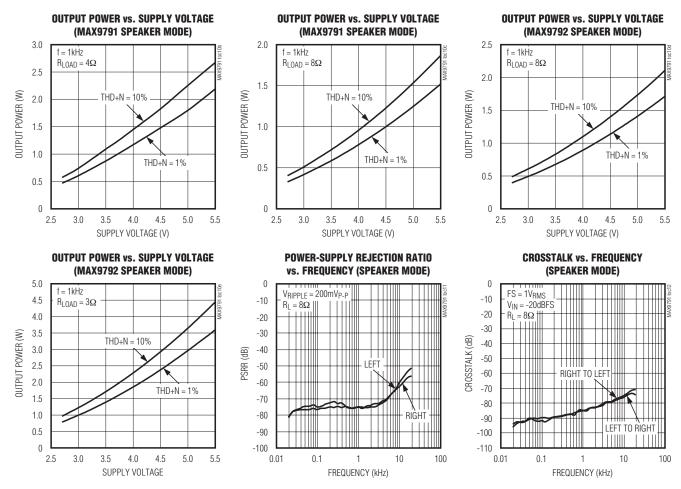
MAX9791/MAX9792





 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)

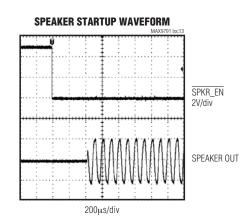


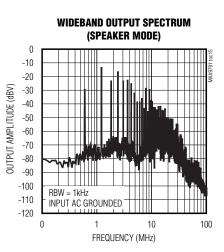


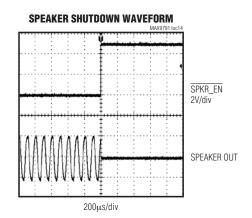
### **Typical Operating Characteristics (continued)**

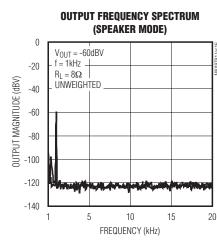
 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)

### SPEAKER





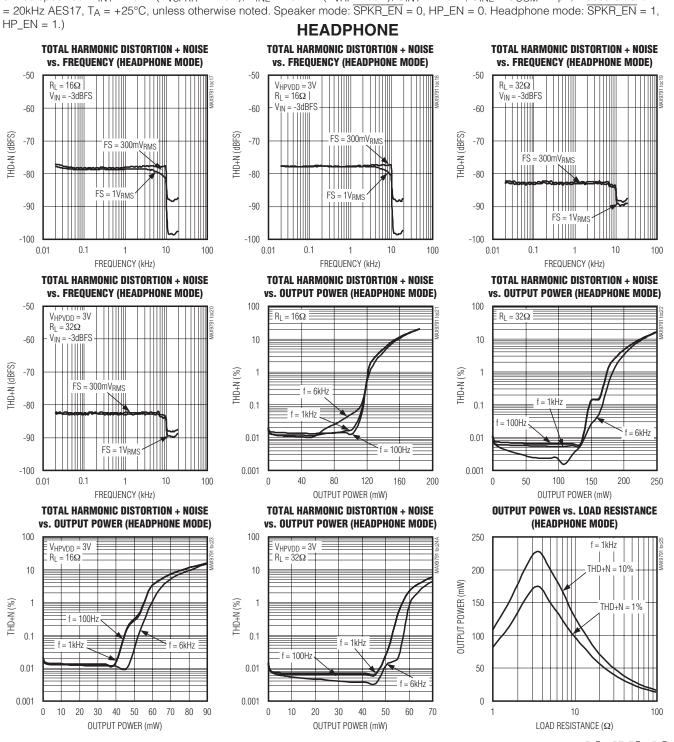




 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (Ayspkg = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (Aypg = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW

**Typical Operating Characteristics (continued)** 



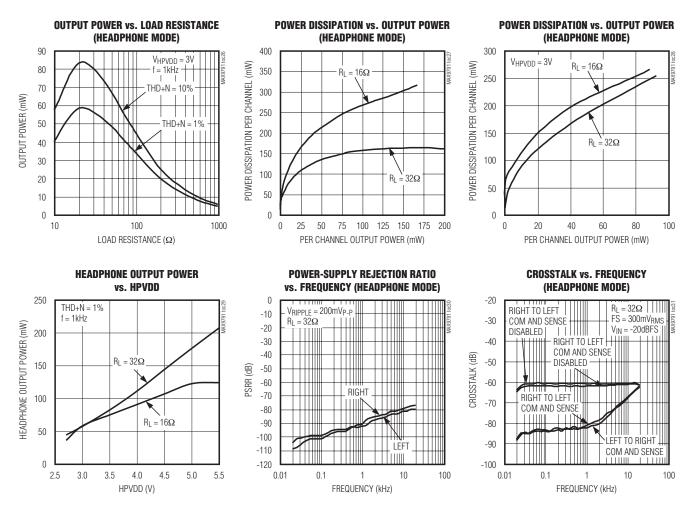


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### **Typical Operating Characteristics (continued)**

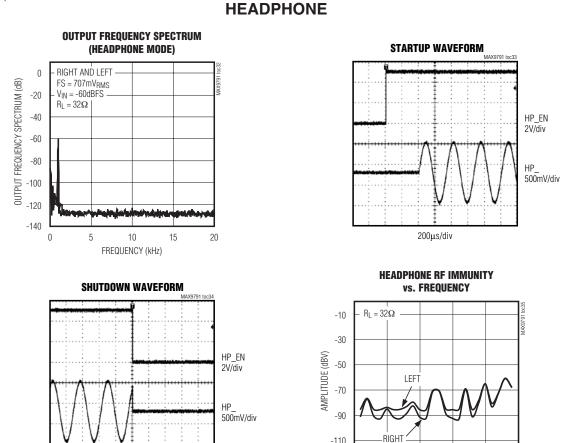
 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)

#### **HEADPHONE**



### Typical Operating Characteristics (continued)

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)



200µs/div

-130

500

1000

1500

FREQUENCY (MHz)

2000

2500

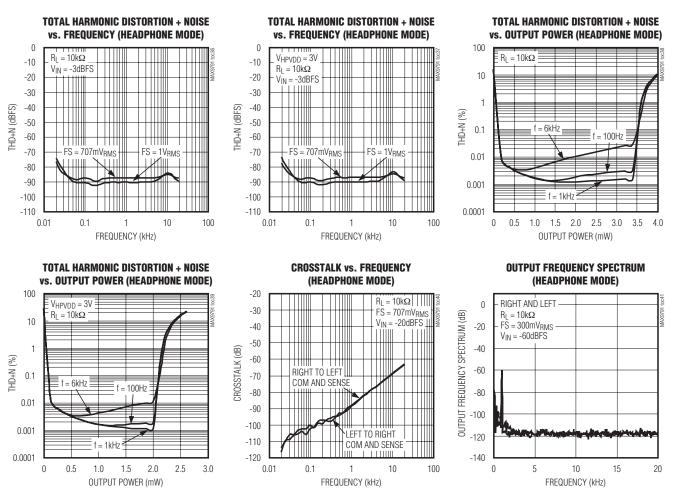
3000

MAX9791/MAX9792

### **Typical Operating Characteristics (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu\text{F}, C1 = C2 = 1\mu\text{F}, R_L = \infty, unless otherwise specified. R_{IN1} = 20k\Omega (A_{VSPKR} = 12dB), R_{IN2} = 40.2k\Omega (A_{VHP} = 0dB), C_{IN1} = 470n\text{F}, C_{IN2} = C_{COM} = 1\mu\text{F}, measurement BW = 20kHz AES17, T_A = +25^{\circ}\text{C}, unless otherwise noted. Speaker mode: SPKR_EN = 0, HP_EN = 0. Headphone mode: SPKR_EN = 1, HP_EN = 1.)$ 

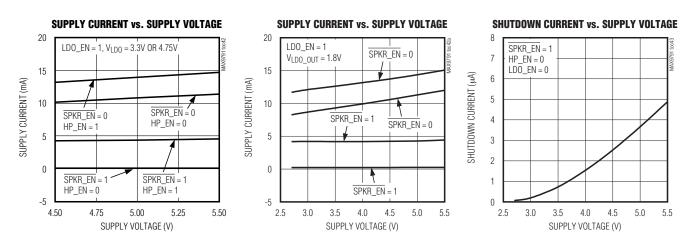




### **Typical Operating Characteristics (continued)**

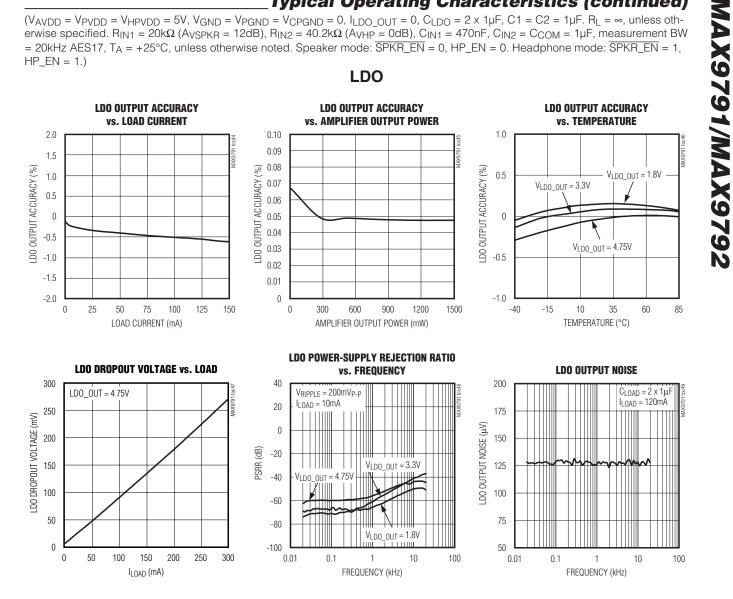
 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)

### GENERAL



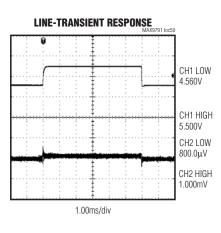
### **Typical Operating Characteristics (continued)**

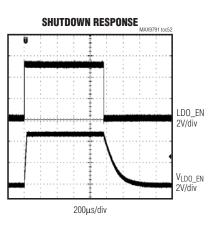
 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17,  $T_A = +25^{\circ}C$ , unless otherwise noted. Speaker mode:  $\overline{SPKR_EN} = 0$ , HP\_EN = 0. Headphone mode:  $\overline{SPKR_EN} = 1$ ,  $HP_EN = 1.)$ 

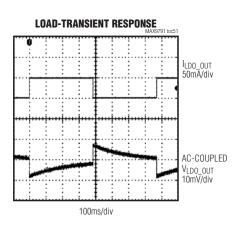


### **Typical Operating Characteristics (continued)**

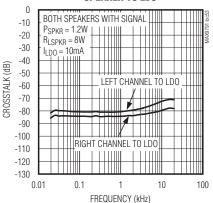
 $(V_{AVDD} = V_{PVDD} = V_{HPVDD} = 5V, V_{GND} = V_{PGND} = V_{CPGND} = 0, I_{LDO_OUT} = 0, C_{LDO} = 2 \times 1\mu$ F, C1 = C2 = 1 $\mu$ F. R<sub>L</sub> =  $\infty$ , unless otherwise specified. R<sub>IN1</sub> = 20k $\Omega$  (A<sub>VSPKR</sub> = 12dB), R<sub>IN2</sub> = 40.2k $\Omega$  (A<sub>VHP</sub> = 0dB), C<sub>IN1</sub> = 470nF, C<sub>IN2</sub> = C<sub>COM</sub> = 1 $\mu$ F, measurement BW = 20kHz AES17, T<sub>A</sub> = +25°C, unless otherwise noted. Speaker mode: SPKR\_EN = 0, HP\_EN = 0. Headphone mode: SPKR\_EN = 1, HP\_EN = 1.)







CROSSTALK vs. FREQUENCY SPEAKER TO LDO



### MAX9791 Pin Description

PIN	NAME	FUNCTION
1	SPKR_INL	Left-Channel Speaker Amplifier Input
2	HP_INR	Right-Channel Headphone Amplifier Input
3	HP_INL	Left-Channel Headphone Amplifier Input
4	COM	Common-Mode Voltage Sense Input
5	GND	Signal Ground. Star connect to PGND.
6	LDO_OUT	LDO Output. Bypass the MAX9791A/MAX9791B with two 1µF ceramic low ESR capacitors to GND. Bypass the MAX9791C with two 2µs ceramic low ESR capacitors to GND.
7	AVDD	Positive Power-Supply and LDO Input. Bypass with a 0.1µF and two 1µF capacitors to GND.
8	LDO_EN	LDO Enable. Connect LDO_EN to AVDD to enable the LDO.
9	HPR	Right-Channel Headphone Amplifier Output
10	HPL	Left-Channel Headphone Amplifier Output
11	SENSE	Headphone Ground Sense
12	CPVSS	Headphone Amplifier Negative Power Supply. Connect a 1µF capacitor between CPVSS and PGND.
13	C1N	Charge-Pump Flying Capacitor Negative Terminal. Connect a 1µF capacitor between C1P and C1N.
14	CPGND	Charge-Pump Ground. Connect directly to PGND plane.
15	C1P	Charge-Pump Flying Capacitor Positive Terminal. Connect a 1µF capacitor between C1P and C1N.
16	HPVDD	Headphone Amplifier Positive Power Supply. Connect a 10µF capacitor between HPVDD and PGND.
17, 26	PVDD	Speaker Amplifier Power-Supply Input. Bypass with a 0.1µF capacitor to PGND.
18	OUTL-	Left-Channel Speaker Amplifier Output, Negative Phase
19	OUTL+	Left-Channel Speaker Amplifier Output, Positive Phase
20, 23	PGND	Power Ground. Star connect to GND.
21	BEEP	PC Beep Input. Connect to GND if beep detection function is disabled.
22	HP_EN	Active-High Headphone Amplifier Enable
24	OUTR+	Right-Channel Speaker Amplifier Output, Positive Phase
25	OUTR-	Right-Channel Speaker Amplifier Output, Negative Phase
27	SPKR_EN	Active-Low Speaker Amplifier Enable
28	SPKR_INR	Right-Channel Speaker Amplifier Input
	EP	Exposed Pad. Connect to GND.

### MAX9792 Pin Description

PIN	NAME	FUNCTION
1, 5	GND	Signal Ground. Star connect to PGND.
2	HP_INR	Right-Channel Headphone Amplifier Input
3	HP_INL	Left-Channel Headphone Amplifier Input
4	COM	Common-Mode Voltage Sense Input
6	LDO_OUT	LDO Output. Bypass with two 1µF ceramic low ESR capacitors to GND.
7	AVDD	Positive Power Supply and LDO Input. Bypass with a 0.1µF and two 1µF capacitors to GND.
8	LDO_EN	LDO Enable. Connect LDO_EN to AVDD to enable the LDO.
9	HPR	Right-Channel Headphone Amplifier Output
10	HPL	Left-Channel Headphone Amplifier Output
11	SENSE	Headphone Ground Sense
12	CPVSS	Headphone Amplifier Negative Power Supply. Connect a 1µF capacitor between CPVSS and PGND.
13	C1N	Charge-Pump Flying Capacitor Negative Terminal. Connect a 1µF capacitor between C1P and C1N.
14	CPGND	Charge-Pump Ground. Connect directly to PGND plane.
15	C1P	Charge-Pump Flying Capacitor Positive Terminal. Connect a 1µF capacitor between C1P and C1N.
16	HPVDD	Headphone Amplifier Positive Power Supply. Connect a 10µF capacitor between HPVDD and PGND.
17, 26	PVDD	Speaker Amplifier Power-Supply Input. Bypass with a 0.1µF capacitor to PGND.
18, 25	OUT-	Speaker Amplifier Output, Negative Phase
19, 24	OUT+	Speaker Amplifier Output, Positive Phase
20, 23	PGND	Power Ground. Star connect to GND.
21	BEEP	PC Beep Input. Connect to GND if beep detection function is disabled.
22	HP_EN	Active-High Headphone Amplifier Enable
27	SPKR_EN	Active-Low Speaker Amplifier Enable
28	SPKR_IN	Speaker Amplifier Input
_	EP	Exposed Pad. Connect to GND.

### **Detailed Description**

The MAX9791 combines a stereo 2W Class D power amplifier, a stereo 175mW DirectDrive headphone amplifier, and a 120mA LDO linear regulator in a single device. The MAX9792 combines a mono 3W Class D power amplifier, a stereo 175mW DirectDrive headphone amplifier, and a 120mA LDO linear regulator in a single device.

The MAX9791/MAX9792 feature wake-on-beep detection, comprehensive click-and-pop suppression, lowpower shutdown mode, and excellent RF immunity. These devices incorporate an integrated LDO that serves as a clean power supply for CODEC or other circuits. The MAX9791/MAX9792 are Windows Vista Premium compliant. See Table 1 for a comparison of the Windows Vista Premium specifications and MAX9791/ MAX9792 specifications. The MAX9791/MAX9792 feature spread-spectrum modulation and active emission limiting circuitry that offers significant improvements to switch-mode amplifier technology. These devices offer Class AB performance with Class D efficiency in a minimal board-space solution.

The headphone amplifiers use Maxim's DirectDrive architecture to eliminate the bulky output DC-blocking capacitors required by traditional headphone amplifiers. A charge pump inverts the positive supply (HPVDD) to create a negative supply (CPVSS). The headphone amplifiers operate from these bipolar supplies with their outputs biased about GND. The benefit of the GND bias is that the amplifier outputs no longer have a DC component (typically V<sub>DD</sub>/2). This feature eliminates the large DC-blocking capacitors required with conventional headphone amplifiers to

M/IXI/M



Table 1. Windows Premium Mobile Vista Specifications vs. MAX9791/MAX9792Specifications

DEVICE TYPE	REQUIREMENT	WINDOWS PREMIUM MOBILE VISTA SPECIFICATIONS	MAX9791/MAX9792 TYPICAL PERFORMANCE
	THD+N	≤ -65dB FS [100Hz, 20kHz]	87dBFS [100Hz, 20kHz]
Analog Line-Out Jack ( $R_L = 10k\Omega$ , FS = 0.707V <sub>RMS</sub> )	Dynamic range with signal present	≤ -80dBV, A-weighted [20Hz, 20kHz]	-98.9dB A-weighted [20Hz, 20kHz]
	Line output crosstalk	≤ -50dB [20Hz, 15kHz]	64dB [20Hz, 15kHz]
	THD+N	≤ -45dB FS [100Hz, 20kHz]	82dBFS [100Hz, 20kHz]
Analog Headphone-Out Jack ( $R_L = 32\Omega$ , FS =	Dynamic range with signal present	≤ -60dBV, A-weighted [20Hz, 20kHz]	-91.5dB A-weighted [20Hz, 20kHz]
0.300V <sub>RMS</sub> )	Headphone output crosstalk	≤ -50dB [20Hz, 15kHz]	64dB [20Hz, 15kHz]

**Note:** THD+N, dynamic range with signal present, and crosstalk should be measured in accordance with AES17 audio measurements standards.

conserve board space and system cost, as well as improve low-frequency response and distortion.

The MAX9791/MAX9792 amplifiers feature an undervoltage lockout that prevents operation from an insufficient power supply and click-and-pop suppression that eliminates audible transients on startup and shutdown. The amplifiers include thermal overload and short-circuit protection.

#### **Class D Speaker Amplifier**

The MAX9791/MAX9792 integrate a filterless class D amplifier that offers much higher efficiency than class AB amplifiers. The high efficiency of a Class D amplifier is due to the switching operation of the output stage transistors. In a Class D amplifier, the output transistors act as current steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I2R loss of the MOSFET on-resistance and quiescent current overhead.

The theoretical best efficiency of a linear amplifier is 78%, however, that efficiency is only exhibited at peak output power. Under normal operating levels (typical music reproduction levels), efficiency falls below 45%, whereas the MAX9791/MAX9792 exhibit 67% efficiency under the same conditions (Figure 1).

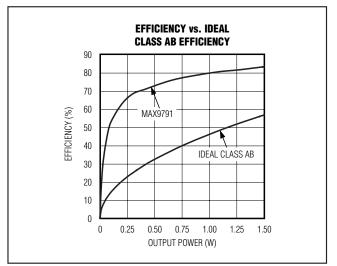


Figure 1. MAX9791 Efficiency vs. Class AB Efficiency

#### Ultra-Low EMI Filterless Output Stage

In traditional Class D amplifiers, the high dv/dt of the rising and falling edge transitions resulted in increased electromagnetic-interference (EMI) emissions, which required the use of external LC filters or shielding to meet EN55022B EMI regulation standards. Limiting the dv/dt normally results in decreased efficiency. Maxim's active emissions limiting circuitry actively limits the dv/dt of the rising and falling edge transitions, providing reduced EMI emissions while maintaining up to 83% efficiency.

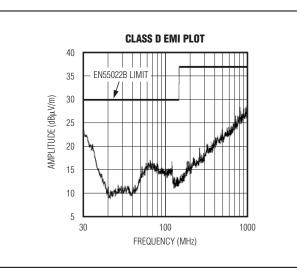


Figure 2. EMI with 30cm of Speaker Cable

In addition to active emission limiting, the MAX9791/ MAX9792 feature spread-spectrum modulation that flattens the wideband spectral components. Proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency (see the *Typical Operating Characteristics*). In spread-spectrum modulation mode, the switching frequency varies randomly by ±15kHz around the center frequency (530kHz). The effect is to reduce the peak energy at harmonics of the switching frequency. Above 10MHz, the wideband spectrum looks like noise for EMI purposes (see Figure 2).

#### Speaker Current Limit

When the output current of the speaker amplifier exceeds the current limit (2A, typ) the MAX9791/ MAX9792 disable the outputs for approximately 100µs. At the end of 100µs, the outputs are re-enabled. If the fault condition still exists, the MAX9791/MAX9792 continue to disable and re-enable the outputs until the fault condition is removed.

#### **DirectDrive Headphone Amplifier**

Traditional single-supply headphone amplifiers bias the outputs at a nominal DC voltage (typically half the supply). Large coupling capacitors are needed to block this DC bias from the headphone. Without these capacitors, a significant amount of DC current flows to the headphone, resulting in unnecessary power dissipation and possible damage to both headphone and headphone amplifier.

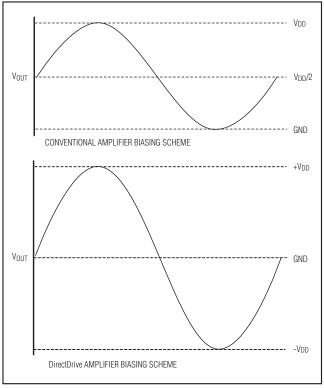


Figure 3. Traditional Amplifier Output vs. MAX9791/MAX9792 DirectDrive Output

Maxim's DirectDrive architecture uses a charge pump to create an internal negative supply voltage. This allows the headphone outputs of the MAX9791/ MAX9792 to be biased at GND while operating from a single supply (Figure 3). Without a DC component, there is no need for the large DC-blocking capacitors. Instead of two large ( $220\mu$ F, typ) capacitors, the MAX9791/MAX9792 charge pump requires two small 1µF ceramic capacitors, conserving board space, reducing cost, and improving the frequency response of the headphone amplifier.

The MAX9791/MAX9792 feature a low-noise charge pump. The nominal switching frequency of 530kHz is well beyond the audio range, and thus does not interfere with audio signals. The switch drivers feature a controlled switching speed that minimizes noise generated by turn-on and turn-off transients. By limiting the switching speed of the charge pump, the di/dt noise caused by the parasitic trace inductance is minimized.



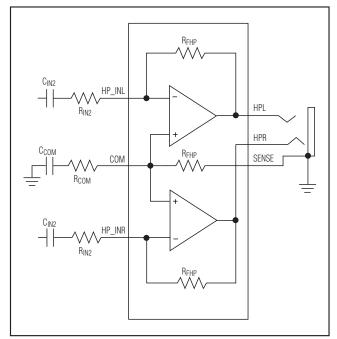


Figure 4. Connecting COM for Ground Sense

#### Common-Mode Sense

Windows Vista-compliant platforms are restricted to only 115m  $\Omega$  of ground return impedance. If the headphone jack ground is connected close to the audio device ground using a solid ground plane, the return path resistance can be quite low. However, it is often necessary to locate some jacks far from the audio device. The MAX9791/MAX9792 COM and SENSE inputs allow the headphone jack to be placed further away from the device without degrading crosstalk performance.

The MAX9791/MAX9792 SENSE and COM inputs sense and correct for the difference between the headphone return and device ground. When using common-mode sense, connect COM through a resistor to GND of the device (Figure 4). For optimum common-mode rejection, use the same value resistors for R<sub>IN2</sub> and R<sub>COM</sub>. To improve AC CMRR, add a capacitor equal to C<sub>IN2</sub> between GND and R<sub>COM</sub>.

Configuring SENSE and COM in this way improves system crosstalk performance by reducing the negative effects of the headphone jack ground return resistance.

Crosstalk in dB = 
$$20 \log \left( \frac{R_G}{R_L + R_S} \right)$$

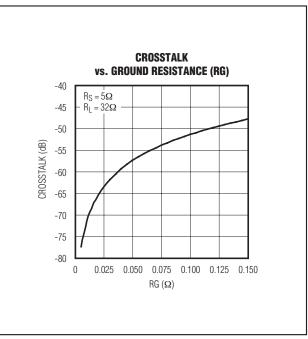


Figure 5. Crosstalk vs. Ground Resistance

The headphone amplifier output impedance, trace resistance, and contact resistance of the jack are grouped together to represent the source resistance, R<sub>S</sub>. The resistance between the load and the sleeve, the sleeve contact resistance, and the system ground return resistance are grouped together to represent the ground resistance, R<sub>G</sub>.

Assuming a typical source resistance of  $5\Omega$ , the ground return impedance would need to be limited to  $115m\Omega$  to meet Windows Vista's crosstalk specification of 50dB (Figure 5). This is further complicated by the fact that the impedance of the sleeve connection in the 3.5mm stereo jack can make up  $30m\Omega$ – $90m\Omega$  alone.

The MAX9791/MAX9792 COM and SENSE inputs reduce crosstalk performance by eliminating effects of  $28.5m\Omega$  of ground return path resistance. If ground sensing is not required, connect COM directly to GND and leave SENSE unconnected (Figure 6).

#### Wake-on-Beep

The MAX9791/MAX9792 beep-detection circuit wakes up the device (speaker and headphone amplifiers) once a qualified beep signal is detected at BEEP and the LDO is enabled. The amplifier wake command from the beep-detection circuit overrides the logic signal applied at HP\_EN and SPKR\_EN.

A qualified BEEP signal consists of a 3.3V typical, 215Hz minimum signal that is present at BEEP for four consecutive cycles. Once the first rising edge transition is detected at BEEP, the beep circuit wakes up and begins counting the beep cycles. Once four consecutive cycles of a qualified beep signal are counted, the device (speaker and headphone amplifiers) enables within 400µs. If the first rising edge is not followed by three consecutive rising edges within 16ms, the device remains shutdown (i.e., glitch protection).

The device (speaker and headphone amplifiers) returns to its programmed logic state once 246ms has elapsed from the time the last rising edge was detected. This 246ms amplifier hold time ensures complete beep profiles are passed to the amplifier outputs (Figure 7). Ground BEEP when the wake-on-beep feature is not used. Do not leave BEEP unconnected.

#### Low-Dropout Linear Regulator

The LDO regulator can be used to provide a clean power supply to a CODEC or other circuitry. The LDO can be enabled independently of the audio amplifiers. Set LDO\_EN = AVDD to enable the LDO or set LDO\_EN = GND to disable the LDO. The LDO can provide up to 120mA of continuous current.

**Speaker and Headphone Amplifier Enable** The MAX9791/MAX9792 feature control inputs for the independent enabling of the speaker and headphone amplifiers, allowing both to be active simultaneously if required. Driving SPKR\_EN high disables the speaker amplifiers. Driving HP\_EN low independently disables the headphone amplifiers. For applications that require only one of the amplifiers to be on at a given

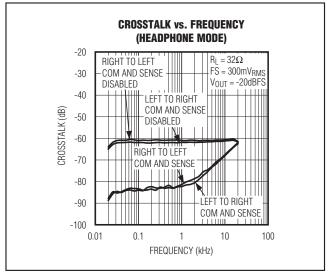


Figure 6. MAX9791/MAX9792 COM and SENSE Inputs Reduce Crosstalk

time, connect SPKR\_EN and HP\_EN together, allowing a single logic voltage to enable either the speaker or the headphone amplifier as shown in Figure 8.

#### Shutdown

The MAX9791/MAX9792 feature a low-power shutdown mode, drawing 3.3µA of supply current. By disabling the speaker, headphone amplifiers, and the LDO, the MAX9791/MAX9792 enter low-power shutdown mode. Set SPKR\_EN to AVDD and HP\_EN and LDO\_EN to GND to disable the speaker amplifiers, headphone amplifiers, and LDO, respectively.

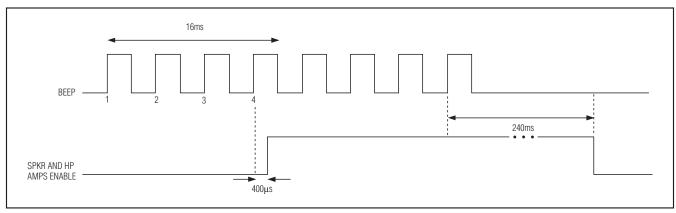


Figure 7. Qualified BEEP Signal Timing

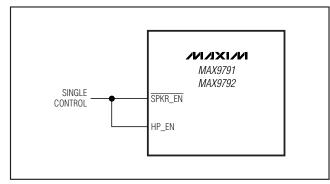


Figure 8. Enabling Either the Speaker or Headphone Amplifier with a Single Control Pin

#### Click-and-Pop Suppression

The MAX9791/MAX9792 feature a common-mode bias voltage of 0V. A 0V BIAS allows the MAX9791/MAX9792 to quickly turn on/off with no resulting clicks and pops. With the HDA CODEC outputs biased and the MAX9791/MAX9792 inputs sitting as 0V in shutdown and normal operation, the R<sub>IN</sub> x C<sub>IN</sub> time constant is eliminated.

#### Speaker Amplifier

The MAX9791/MAX9792 speaker amplifiers feature Maxim's comprehensive, industry leading click-andpop suppression. During startup and shutdown, the click-and-pop suppression circuitry eliminates any audible transient sources internal to the device.

#### Headphone Amplifier

In conventional single-supply headphone amplifiers, the output-coupling capacitor is a major contributor of audible clicks and pops. Upon startup, the amplifier charges the coupling capacitor to its bias voltage, typically  $V_{DD}/2$ . During shutdown, the capacitor is discharged to GND; a DC shift across the capacitor results, which in turn appears as an audible transient at the speaker. Because the MAX9791/MAX9792 do not require output-coupling capacitors, no audible transient occurs.

The MAX9791/MAX9792 headphone amplifiers feature extensive click-and-pop suppression that eliminates any audible transient sources internal to the device.

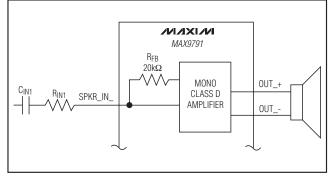


Figure 9. Setting Speaker Amplifier Gain

### **Applications Information**

#### **Filterless Class D Operation**

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost and size and can decrease efficiency and THD+N performance. The traditional PWM scheme uses large differential output swings (2 x PVDD peakto-peak) causing large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering the efficiency.

The MAX9791/MAX9792 do not require an output filter. The devices rely on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, and more efficient solution.

Because the frequency of the MAX9791/MAX9792 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is very small. For optimum results, use a speaker with a series inductance > 10µH. Typical 8 $\Omega$  speakers exhibit series inductances in the 20µH to 100µH range.

#### Setting Speaker Amplifier Gain

External input resistors in conjunction with the internal feedback resistors ( $R_{FSPKR}$ ) set the speaker amplifier gain of the MAX9791/MAX9792. Set gain by using resistor  $R_{IN1}$  as follows (Figure 9):

$$A_{VSPKR} = -4 \left(\frac{20k\Omega}{R_{IN1}}\right) V / V$$

where AVSPKR is the desired voltage gain. An RIN1 of  $20k\Omega$  yields a gain of 4V/V, or 12dB.

#### **Component Selection**

#### **Optional Ferrite Bead Filter**

In applications where speaker leads exceed 15cm, use a filter constructed from a ferrite bead and a capacitor to ground (Figure 10) to provide additional EMI suppression. Use a ferrite bead with low DC resistance, high frequency (> 1.2MHz) impedance of 100 $\Omega$  to 600 $\Omega$ , and rated for at least 1A. The capacitor value varies based on the ferrite bead chosen and the actual speaker lead length. Select the capacitor value based on EMI performance.

#### **Output Power (Headphone Amplifier)**

The headphone amplifiers are specified for the worstcase scenario when both inputs are in phase. Under this condition, the drivers simultaneously draw current from the charge pump, leading to a slight loss in headroom of CPVSS. In typical stereo audio applications, the left and right signals have differences in both magnitude and phase, subsequently leading to an increase in the maximum attainable output power. Figure 11 shows the two extreme cases for in and out of phase. In most cases, the available power lies between these extremes.

#### **Headphone Amplifier Gain**

#### Gain-Setting Resistors

External input resistors in conjunction with the internal feedback resistors ( $R_{FHP}$ ) set the headphone amplifier gain of the MAX9791/MAX9792. Set gain by using resistor  $R_{IN2}$  (Figure 4) as follows:

$$A_{VHP} = -\left(\frac{40.2k\Omega}{R_{IN2}}\right)V / V$$

where  $A_{VHP}$  is the desired voltage gain. An  $R_{IN2}$  of 40.2k  $\!\Omega$  yields a gain of 1V/V, or 0dB.

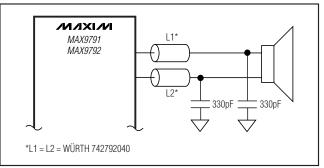


Figure 10. Optional Ferrite Bead Filter

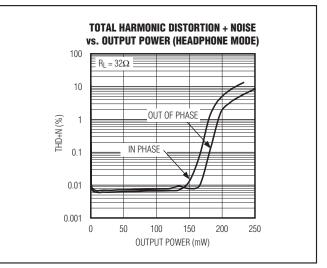


Figure 11. Output Power vs. Supply Voltage with Inputs In/Out of Phase; 32 $\Omega$  Load Conditions and 3.5dB Gain

#### **Power Supplies**

The MAX9791/MAX9792 speaker amplifiers are powered from PVDD with a range from 2.7V to 5.5V. The headphone amplifiers are powered from HPVDD and CPVSS. HPVDD is the positive supply of the headphone amplifiers and charge pump ranging from 2.7V to 5.5V. CPVSS is the negative supply of the headphone amplifiers. The charge pump inverts the voltage at HPVDD, and the resulting voltage appears at CPVSS. AVDD powers the LDO and the remainder of the device. AVDD and PVDD must be tied together. If LDO is enabled, set AVDD and PVDD as specified in the Line Regulation row of the *Electrical Characteristics* table.

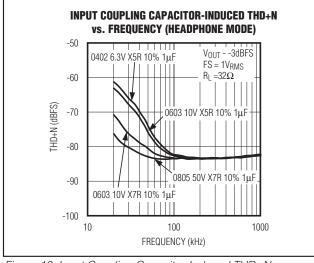


Figure 12. Input Coupling Capacitor-Induced THD+N vs. Frequency

### **Component Selection**

**Speaker Amplifier Power-Supply Input (PVDD)** PVDD powers the speaker amplifiers. PVDD ranges from 2.7V to 5.5V. AVDD and PVDD must be tied together. If LDO is enabled, set AVDD and PVDD as specified in the Line Regulation row of the *Electrical Characteristics* table. Bypass PVDD with a 0.1µF capacitor to PGND. Apply additional bulk capacitance at the device if long input traces between PVDD and the power source are used.

#### Headphone Amplifier Power-Supply Input (HPVDD and CPVSS)

The headphone amplifiers are powered from HPVDD and CPVSS. HPVDD is the positive supply of the headphone amplifiers and ranges from 2.7V to 5.5V. Bypass HPVDD with a 10 $\mu$ F capacitor to PGND. CPVSS is the negative supply of the headphone amplifiers. Bypass CPVSS with a 1 $\mu$ F capacitor to PGND. The charge pump inverts the voltage at HPVDD, and the resulting voltage appears at CPVSS. A 1 $\mu$ F capacitor should be connected between C1N and C1P.

#### Positive Power Supply and LDO Input (AVDD)

The internal LDO and the remainder of the device are powered by AVDD. AVDD ranges from 2.7V to 5.5V. AVDD and PVDD must be tied together. If LDO is enabled, set AVDD and PVDD as specified in LDO line regulation. Bypass AVDD with a 0.1 $\mu$ F capacitor to GND and two 1 $\mu$ F capacitors to GND. Note additional bulk capacitance is required at the device if long input traces between AVDD and the power source are used.

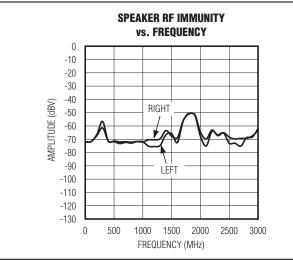


Figure 13. Speaker RF Immunity

#### Input Filtering

**MAX9791/MAX9792** 

The input capacitor ( $C_{IN}$ ), in conjunction with the amplifier input resistance ( $R_{IN}$ ), forms a highpass filter that removes the DC bias from the incoming signal. The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

 $R_{IN\_}$  is the amplifier's external input resistance value. Choose  $C_{IN\_}$  such that  $f_{\text{-}3dB}$  is well below the lowest frequency of interest. Setting  $f_{\text{-}3dB}$  too high affects the amplifier's low frequency response. Use capacitors with adequately low-voltage coefficients (see Figure 12). Capacitors with higher voltage coefficients, such as ceramics, result in increased distortion at low frequencies.

#### **Charge-Pump Capacitor Selection**

Use capacitors with an ESR less than  $100m\Omega$  for optimum performance. Low ESR ceramic capacitors minimize the output resistance of the charge pump. For best performance over the extended temperature range, select capacitors with an X7R dielectric.

#### Flying Capacitor (C1)

The value of the flying capacitor (C1) affects the load regulation and output resistance of the charge pump. A C1 value that is too small degrades the device's ability to provide sufficient current drive, which leads to a loss of output voltage. Connect a  $1\mu$ F capacitor between C1P and C1N.



Charge-Pump Output Capacitor (C2)

Connect a 1µF capacitor between CPVSS and PGND.

#### LDO Output Capacitor (CLDO)

Connect 2 x 1 $\mu$ F capacitors between LDO\_OUT and GND for 4.75V and 3.3V LDO options (MAX979\_A and MAX979\_B, respectively). Connect two parallel 2 $\mu$ F capacitors between LDO\_OUT and GND for the 1.8V LDO option (MAX979\_C).

#### Layout and Grounding

Proper layout and grounding are essential for optimum performance. Use large traces for the power-supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance, as well as route heat away from the device. Good grounding improves audio performance, minimizes crosstalk between channels, and prevents switching noise from coupling into the audio signal. Connect PGND and GND together at a single point on the PCB. Route PGND and all traces that carry switching transients away from GND, and the traces and components in the audio signal path.

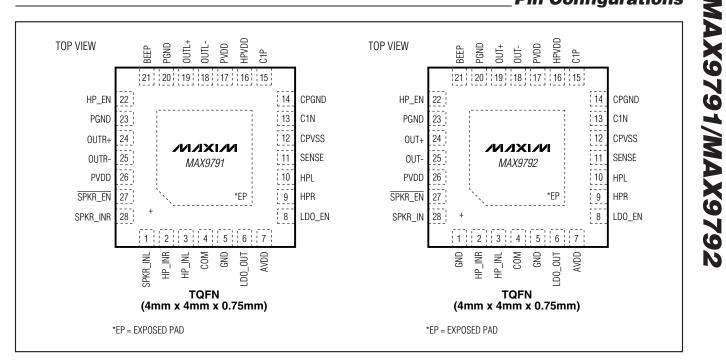
Connect C2 to the PGND plane. Place the chargepump capacitors (C1, C2) as close as possible to the device. Bypass PVDD with a  $0.1\mu$ F capacitor to PGND. Place the bypass capacitors as close as possible to the device. The MAX9791/MAX9792 is inherently designed for excellent RF immunity. For best performance, add ground fills around all signal traces on top or bottom PCB planes.

Use large, low-resistance output traces. As load impedance decreases, the current drawn from the device outputs increase. At higher current, the resistance of the output traces decrease the power delivered to the load. For example, if 2W is delivered from the speaker output to a 4 $\Omega$  load through a 100m $\Omega$  trace, 49mW is wasted in the trace. If power is delivered through a 10m $\Omega$  trace, only 5mW is wasted in the trace. Large output, supply, and GND traces also improve the power dissipation of the device.

The MAX9791/MAX9792 thin QFN package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by providing a direct heat conduction path from the die to the printed circuit board. Connect the exposed thermal pad to GND by using a large pad and multiple vias to the GND plane.

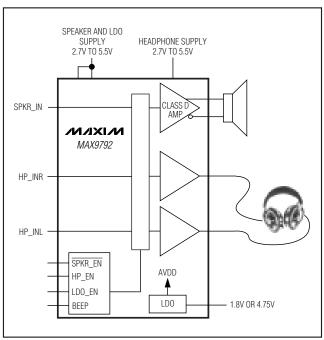
Chip Information

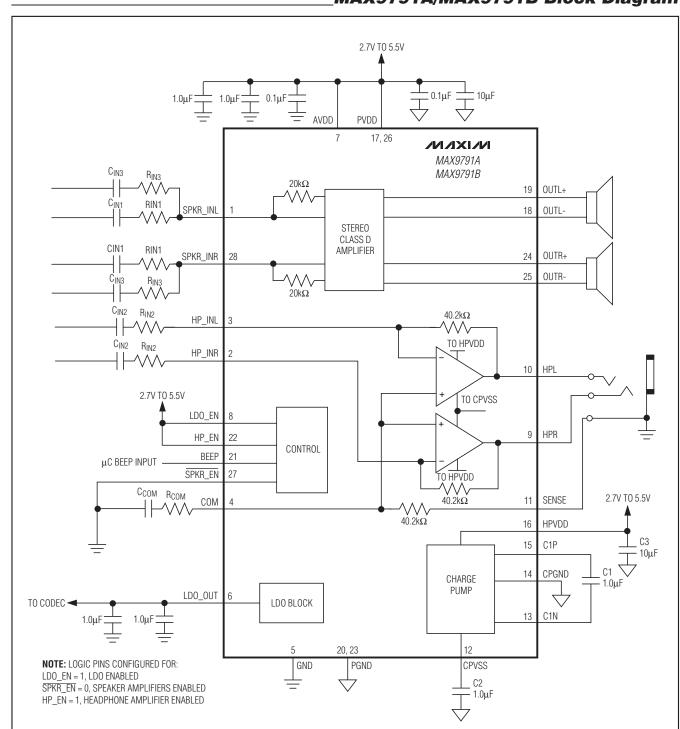
PROCESS: BiCMOS



### \_ Pin Configurations

### Simplified Block Diagrams (continued)

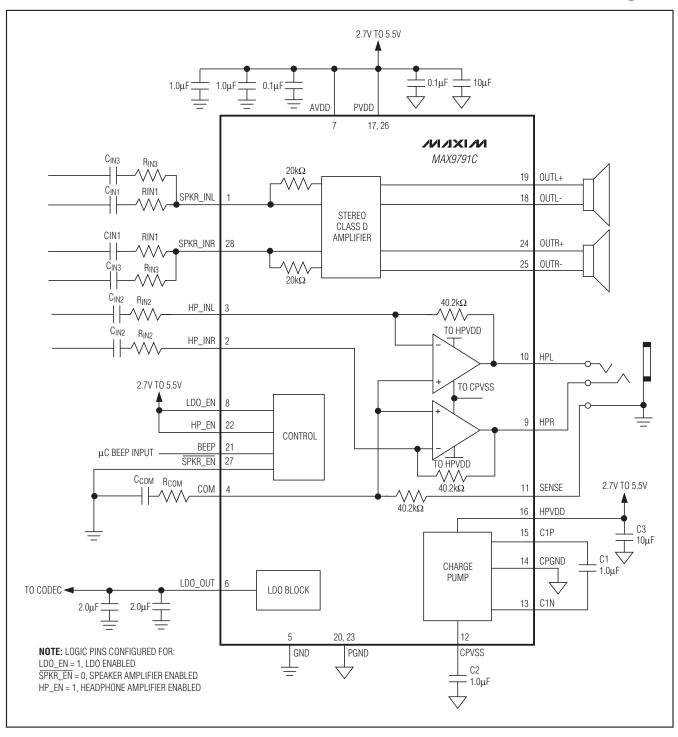




MAX9791A/MAX9791B Block Diagram

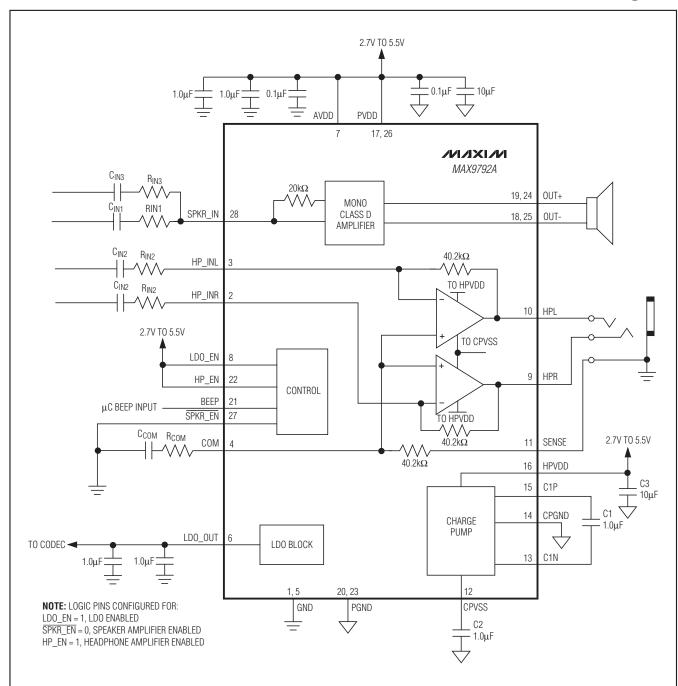
MAX9791/MAX9792

### \_MAX9791C Block Diagram



M/X/M

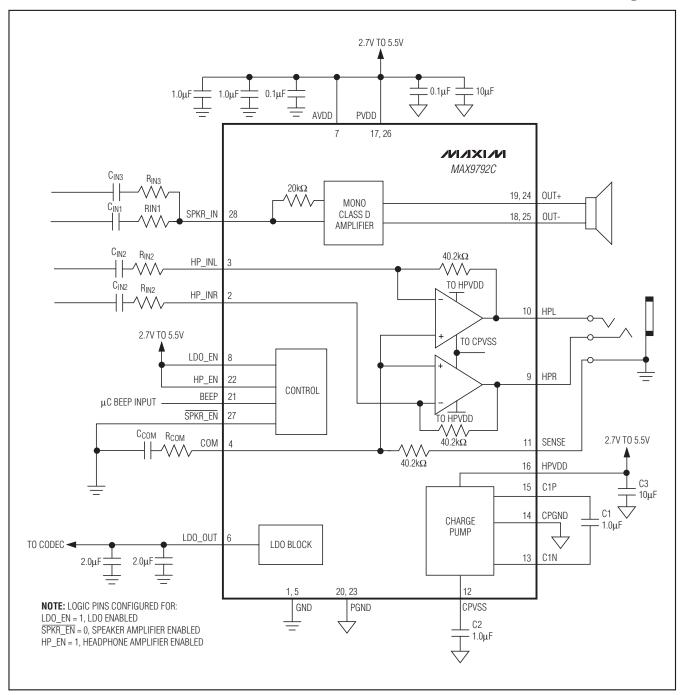




/N/IXI/N

MAX9791/MAX9792

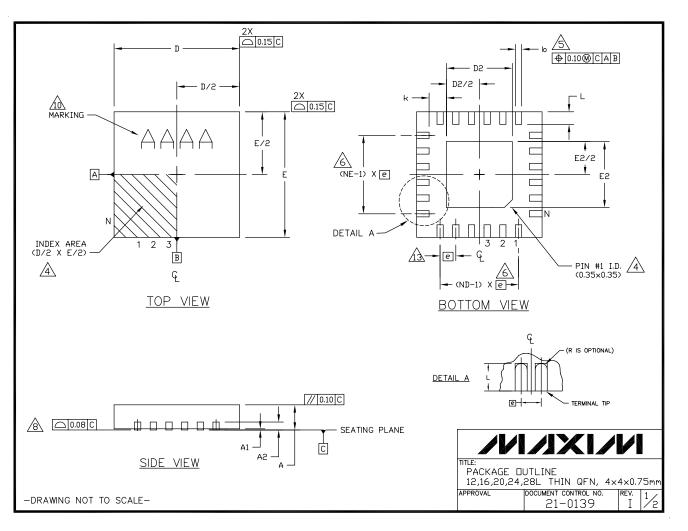
### \_MAX9792C Block Diagram



### **Package Information**

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
28 TQFN-EP	T2844-1	<u>21-0139</u>	<u>90-0068</u>



### **Package Information (continued)**

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

					CUM		DIM	EN2	TUN2								L EXF	DSEI	J PA	n v	ARIA		13
PKG	12	L 4×4	4	16L 4×4		4	20	L 4x	4	24	4L 4×	<b>&lt;</b> 4	28	BL 4×	:4		PKG.		D2			E2	
REF.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.		CODES	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80		T1244-3	1.95	2.10	2.25	1.95	2.10	2.25
A1	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05		T1244-4	1.95	2.10	2.25	1.95	2.10	2.25
A2	0.	20 REF	-	0.	20 REI	F	0.	20 RE	F	0	20 RE	F	0	20 RE	F		T1644-3	1.95	2.10	2.25	1.95	2.10	2.25
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25		T1644-4	1.95	2.10	2.25	1.95	2.10	2.25
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10		T2044-2	1.95	2.10	2.25	1.95	2.10	2.25
E	3.90				4.00	4.10		4.00	4.10			4.10	3.90		4.10		T2044-3	1.95	2.10	2.25	1.95	2.10	2.25
e		80 BS	_		65 BS			50 BS			.50 BS			40 BS			T2444-2	1.95	2.10	2.25	1.95	2.10	2.25
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-		T2444-3	2.45	2.60	2.63	2.45	2.60	2.63
L	0.45		0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50		T2444-4	2.45	2.60	2.63	2.45	2.60	2.63
N		12			16			20			24		<u> </u>	28			T2444N-4	2.45	2.60	2.63	2.45	2.60	2.63
ND		3			4			5			6			7			T2444M-1	2.45	2.60	2.63	2.45	2.60	2.63
NE Jedec Var.		3 VGGB	_		4 VGGC			5 /GGD-1			6 VGGD-	-	<u> </u>	7 VGGE			T2844-1	2.50	2.60	2.70	2.50	2.60	2.70
. DIM 2. ALL	iensioi _ dime	NSION	IS AR	E IN	MILLI	METER	rs. An																
ALL N I THE MAN DIM ND COF O COF	iensioi _ Dime is The _ Tern Rminal ( Be e	INSION TOTA MINAL HI II EITHEF N & A NE REI ATION RITY A CONFI	IS AR AL NU #1 II DENTI R A M PPLII FER IS P APPLI DRMS IR PA	e in Imber Denti Ifier Iold Es to To th Ossib Es to CKAGE	MILLI DF 1 FIER ARE DR MA I META E NUI BLE IN BLE IN D THE IEDEC E DRI	METER TERMIN AND OPTIO ARKED ARK	RS. AN NALS. TERMII INAL, FEAT ED TE OF TI YMMET JSED 20, EX TON F	IGLES BUT URE, RMIN/ RMIN/ RMIN/ RICAI HEAT CEPT	ARE NUMBE MUST AL AN IALS [ L FAS SINK FOR	IN DI RING BE L ID IS IN EA HIDN. SLUC T244	EGREE CONV DCATE MEAS CH D 5 AS 4-3,	ES. ENTID ED VI SURED AND VELL	THIN BETW E SII AS T	THE Z	ZONE 0.25mm SPECT ERMIN	INDICA n AND TVELY ALS.	JESD 95-1 ITED. THE 0.30mm FRE	TERMIN	IAL #	1 IDE	NTIFIE		

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	11/08	Initial release	—
1	6/10	Adding MAX9791C/MAX9792C versions	1–7, 10, 13–16, 19, 21–30

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